



- NOTES:
- 1) R10 for test purposes only
 - 2) limit avg output power to 30W due to L1 (max. 3Arms on both windings)
 - 3) due to losses provide copper area to Q5/D6

Revision History	
Revision	Notes
A	* First release
B	* modified PreReg & UVLO
C	* reduced noise by snubber and cap ladder

Orderable: EVM_orderable	Designed for: Public Release	Mod. Date: 6/22/2018
TID #: TID	Project Title: wide Vin SEPIC	
Number: PMP30465	Rev: C	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: [No Variations]	Sheet: 1 of 1
Drawn By:	File: PMP30465RevC.SchDoc	Size: A4
Engineer: B.Geck	Contact: http://www.ti.com/support	



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